

Part Number : 855025011

Product Description : Modular Jack, Right-Angle, Surface Mount, 6/6, Low Profile, Pin-in-Hole-Reflow, Tape & Reel



Series Number : 85502

Status : Active

Product Category : Modular Jacks and Plugs

Documents & Resources

Drawings

[Drawing 855025011_sd.pdf](#)

[Packaging Design Drawing PK-85502-001.pdf](#)

3D Models and Design Files

[3D Model 855025011_stp.zip](#)

Specifications

[Application Specification AS-85513-001-001.pdf](#)

[Product Specification PS-95501-001.pdf](#)

Product Environment Compliance

Compliance

GADSL/IMDS	Not Relevant
China RoHS	
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2023)8585-DC (23 Jan 2024)
EU RoHS	Compliant per EU 2015/863

Multiple Part Product Compliance Statements

- Eu RoHS
- REACH SVHC
- Low-Halogen

Multiple Part Industry Compliance Documents

- IPC 1752A Class C

- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

EU RoHS Certificate of Compliance

Part Details

General

Status	Active
Category	Modular Jacks and Plugs
Series	85502
Description	Modular Jack, Right-Angle, Surface Mount, 6/6, Low Profile, Pin-in-Hole-Reflow, Tape & Reel
Comments	Reflow capable
Component Type	PCB Jack
Magnetic	No
Performance Category	3
Power over Ethernet (PoE)	N/A
Product Family	Magnetic and Modular Jacks/Plugs
Product Name	Modular Jack 6/6
UPC	822350901765

Agency

UL	E107635
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Electrical

Current - Maximum per Contact	1.5A
Shielded	No
Voltage - Maximum	125V DC

Physical

Boot Color	N/A
Color - Resin	Black
Durability (mating cycles max)	2500
Flammability	94V-0

Inverted / Top Latch	No
Jack Height	11.50mm
Lightpipes/LEDs	None
Material - Metal	Copper Alloy
Material - Plating Mating	Gold over Palladium Nickel
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	2.085/g
Orientation	Right Angle (Side Entry)
Packaging Type	Embossed Tape on Reel
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness - Recommended	1.57mm
Pitch - Mating Interface	1.02mm
Pitch - Termination Interface	1.27mm
Plating min - Mating	0.051µm, 0.600µm
Plating min - Termination	1.905µm
Port Configuration	1x1
Positions / Loaded Contacts	6/6
Temperature Range - Operating	-40° to +85°C
Termination Interface Style	Surface Mount
Waterproof / Dustproof	No
Wire/Cable Type	N/A

Solder Process Data

Max-Duration	45
Lead-Free Process Capability	REFLOW
Max-Cycle	3
Max-Temp	260

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